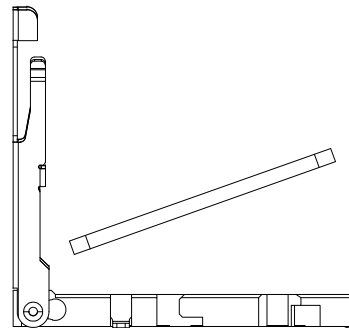
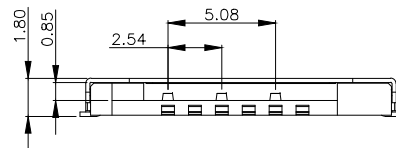
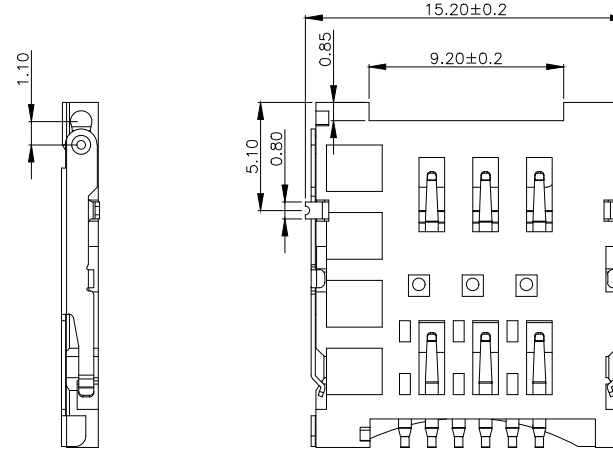
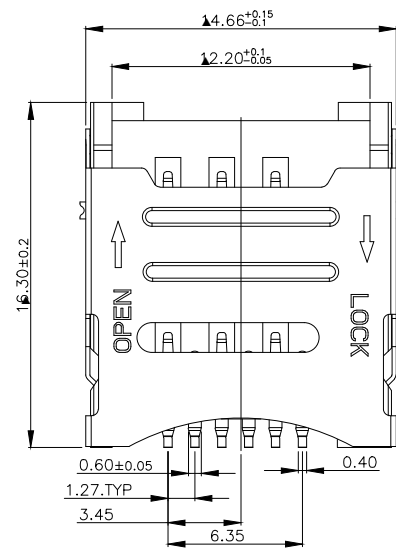
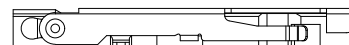




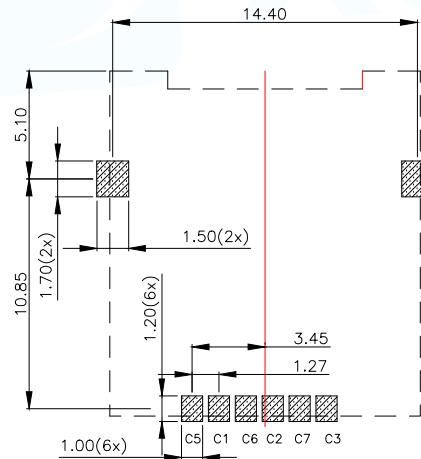
STEP 1 INSERT MICRO SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH



PAD AREA

KEEP OUT AREA

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05

MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A

一、材质和镀涂:

1、胶芯: LCP,UL 94V-0,黑色

2、端子: 磷铜C5210-H,T=0.15,
全区镍底30u"MIN

触点镀金GOLD FLASH0.6-1.0u"

焊脚双面镀亮锡50-80u'

3.定位脚:磷铜C2680-H,T=0.20,

全区镍底30u"MIN,镀亮锡50-80u"

4、外壳: 不锈钢 T=0.2

二、技术参数:

接触电阻: 100M Ω MAX绝缘阻抗: 1000M Ω MIN(500DC)

额定电流: 每个接触件1A MAX

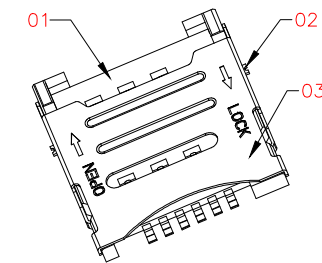
额定电压: 30V MAX(DC)

耐 压: 500V R.M.S/MIN

使用温度: -40℃~85℃

湿 度: 80% R.H MAX

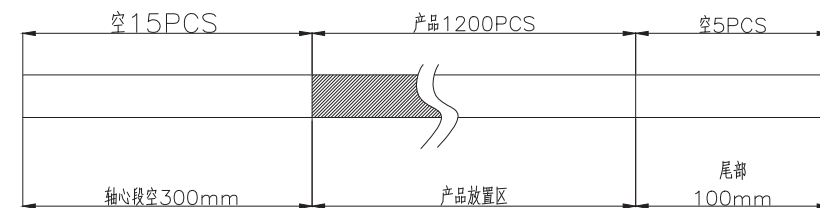
寿 命: >3000次



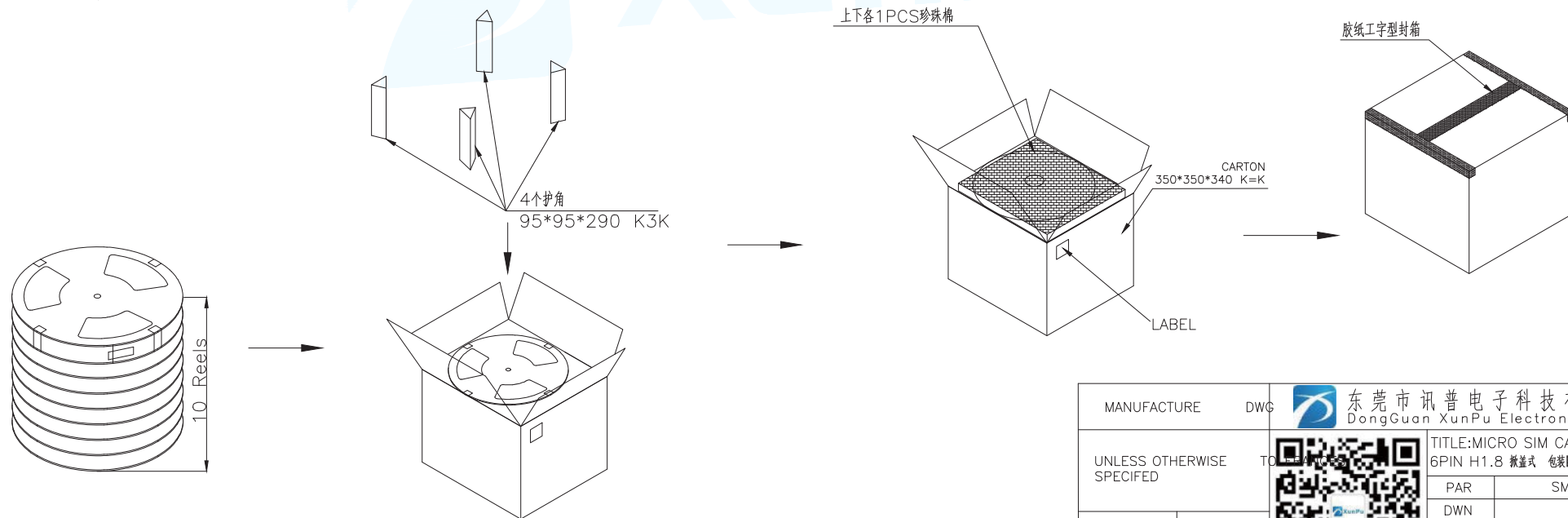
MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: MICRO SIM CARD HINGED 6PIN H1.8 数量式
			PAR SMC-216
DECIMALS:	ANGLES:		DWN
X.: ± 0.50	X': $\pm 2^\circ$		CHKD
X.X: ± 0.30	X.X': $\pm 1^\circ$		APVD
X.XX: ± 0.20			SCALE 1:1
CUSTOMER COPY		UNIT: MM	SIZE: A4
		SHEET: 1F1	REV: A



- 1.每卷包装数量:1200PCS/每卷
2.卷带包装方式:



- 3.每箱包装数量:12000PCS/箱
- 4.纸箱350mm*350mm*440mm(内部尺寸),材质K=K



MANUFACTURE		DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED		TO REFERENCE		TITLE:MICRO SIM CARD HINGED 6PIN H1.8 掀盖式 包装图	
				PAR	SMC-216
DECIMALS:	ANGLES:			DWN	
				CHKD	
X.:±0.50	X.:±2°			APVD	
X.X:±0.30	X.X:±1°			SCALE1:1	UNIT:MM
X.XX:±0.20				SIZE:A4	SHEET:1F1
CUSTOMER COPY				REV:A	